



NGAC G907-52 is an epoxy formulation designed for electrical encapsulating and potting applications. This low viscosity adhesive provides excellent flowability, surface wetting and minimal shrinkage upon cure

NGAC G907-52 adheres extremely well to ceramics and glass, most metals and plastics. It is highly resistant to moisture, weather, petroleum products, alcohols, salts, alkalis and acids. It can be cured at room temperature or more quickly at elevated temperatures. This adhesive passes NASA Outgassing Specification requirements.

Please email info@nextgenadhesives.com or call (978) 436-9600 for a FREE SAMPLE.